

## 30V N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SMC4738 is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density and trench DMOS technology.

It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

These devices are well suited for high efficiency fast switching applications.

*SMC4738PD-TRG ROHS Compliant This is Halogen Free*

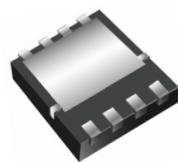
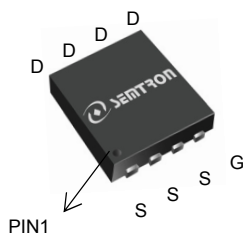
### FEATURE

- ◆ 30V / 45A
- ◆  $R_{DS(ON)} = 6.5m\Omega(typ.)@V_{GS} = 10V$
- ◆  $R_{DS(ON)} = 9.5m\Omega(typ.)@V_{GS} = 4.5V$
- ◆ Fast switch
- ◆ Low gate charge
- ◆ Improved dv/dt capability
- ◆ High power and current handling capability
- ◆ 100% EAS Guaranteed

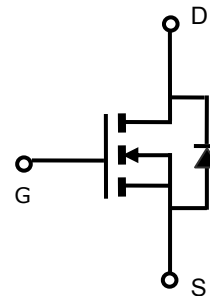
### APPLICATIONS

- ◆ High Frequency DC/DC converters
- ◆ POL Applications
- ◆ SMPS 2<sup>nd</sup> SR

### PIN CONFIGURATION



DFN5X6A-8  
Top View



### PART NUMBER INFORMATION

|   |   |
|---|---|
| <p><b>SMC 4738 PD - TR G</b></p> <p>a    b    c    d    e</p> | <p>a : Company name.</p> <p>b : Product Serial number.</p> <p>c : Package code</p> <p>d : Handling code</p> <p>e : Green produce code</p> |
|---|---|

## ORDERING INFORMATION

| Part Number   | Package Code   | Handling Code  | Shipping  |
|---------------|----------------|----------------|-----------|
| SMC4738PD-TRG | PD : DFN5X6A-8 | TR : Tape&Reel | 2.5K/Reel |

※ Year Code : 0 ~ 9, 2010 : 0  
 ※ Week Code : A(1~2) ~ Z(53~54)  
 ※ DFN-56 : Only available in tape and reel packaging.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C Unless otherwise noted)

| Symbol           | Parameter  | Typical               | Unit |
|------------------|--|-----------------------|------|
| V <sub>DSS</sub> | Drain-Source Voltage   | 30                    | V    |
| V <sub>GSS</sub> | Gate-Source Voltage  | ±20                   | V    |
| I <sub>D</sub>   | Continuous Drain Current <sup>A</sup>                            | T <sub>C</sub> =25°C  | 45   |
|                  |  | T <sub>C</sub> =100°C | 28   |
| I <sub>DM</sub>  | Pulsed Drain Current <sup>A</sup>                                | T <sub>C</sub> =25°C  | 60   |
| E <sub>AS</sub>  | Single Pulse Avalanche energy L=0.1mH <sup>B</sup>               | 45                    | mJ   |
| I <sub>AS</sub>  | Avalanche Current <sup>B</sup>                                   | 30                    | A    |
| P <sub>D</sub>   | Power Dissipation <sup>F</sup>                                   | T <sub>C</sub> =25°C  | 32   |
|                  |  | T <sub>C</sub> =100°C | 15   |
| P <sub>D</sub>   | Power Dissipation <sup>A</sup> Surface-mounted                   | T <sub>C</sub> =25°C  | 2.2  |
|                  |  | T <sub>C</sub> =100°C | 1.5  |
| T <sub>J</sub>   | Operation Junction Temperature                                   | -55/150               | °C   |
| T <sub>STG</sub> | Storage Temperature Range  | -55/150               | °C   |
| R <sub>θJA</sub> | Thermal Resistance-Junction to Ambient <sup>C</sup> Steady-State | 45                    | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction to Lead <sup>C</sup> Steady-State    | 3.0                   | °C/W |

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

A. Surface-mounted on FR-4 board using 1 sq-in pad, 1 oz Cu.

B. The EAS data shows Max. rating. The test condition is V<sub>DD</sub>=25V, V<sub>GS</sub>=10V, L=0.1mH, I<sub>AS</sub>=30A, R<sub>G</sub>=25Ω, Starting T<sub>J</sub>=25°C.

C. UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature T<sub>J</sub>=25°C).

F. The power dissipation P<sub>D</sub> is based on T<sub>J</sub>(MAX)=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper.

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ Unless otherwise noted )

| Symbol                    | Parameter                                   | Condition  | Min | Typ        | Max         | Unit      |
|---------------------------|---|--|-----|------------|-------------|-----------|
| <b>Static Parameters</b>  |   |  |     |            |             |           |
| V(BR)DSS                  | Drain-Source Breakdown Voltage <sup>D</sup> | $V_{GS}=0V, I_D=250\mu A$                          | 30  |            |             | V         |
| $V_{GS(th)}$              | Gate Threshold Voltage <sup>D</sup>         | $V_{DS}=V_{GS}, I_D=250\mu A$                      | 1.0 | 1.6        | 2.5         | V         |
| $I_{GSS}$                 | Gate Leakage Current                        | $V_{DS}=0V, V_{GS}=\pm 20V$                        |     |            | $\pm 100$   | nA        |
| $I_{DSS}$                 | Zero Gate Voltage Drain Current             | $V_{DS}=30V, V_{GS}=0V$<br>$T_J=25^\circ\text{C}$  |     |            | 1           | $\mu A$   |
|                           |   | $V_{DS}=24V, V_{GS}=0V$<br>$T_J=125^\circ\text{C}$ |     |            | 10          |           |
| $R_{DS(ON)}$              | Drain-source On-Resistance <sup>D</sup>     | $V_{GS}=10V, I_D=16A$<br>$V_{GS}=4.5V, I_D=8A$     |     | 7.0<br>9.5 | 8.5<br>12.5 | $m\Omega$ |
| $G_{fs}$                  | Forward Transconductance <sup>D</sup>       | $V_{DS}=10V, I_D=8A$                               |     | 14         |             | S         |
| <b>Source-Drain Diode</b> |   |  |     |            |             |           |
| $V_{SD}$                  | Diode Forward Voltage <sup>B</sup>          | $I_S=1A, V_{GS}=0V$                                |     | 0.7        | 1.0         | V         |
| $I_S$                     | Continuous Source Current                   |  |     |            | 20          | A         |
| <b>Dynamic Parameters</b> |   |  |     |            |             |           |
| $Q_g(4.5V)$               | Total Gate Charge                           | $V_{DS}=15V, V_{GS}=4.5V$<br>$I_D=20A$             |     | 7.5        |             | nC        |
| $Q_{gs}$                  | Gate-Source Charge                          |  |     | 1.3        |             |           |
| $Q_{gd}$                  | Gate-Drain Charge                           |  |     | 4.5        |             |           |
| $C_{iss}$                 | Input Capacitance                           | $V_{DS}=25V, V_{GS}=0V$<br>$f=1\text{MHz}$         |     | 750        |             | pF        |
| $C_{oss}$                 | Output Capacitance                          |  |     | 150        |             |           |
| $C_{rss}$                 | Reverse Transfer Capacitance                |  |     | 110        |             |           |
| $R_G$                     | Gate Resistance                             | $V_{GS}=0V, V_{DS}=0V,$<br>$F=1\text{MHz}$         |     | 2.6        |             | $\Omega$  |
| $t_{d(on)}$               | Turn-On Time <sup>E</sup>                   | $V_{DD}=15V, V_{GEN}=10V,$<br>$R_G=3.3\Omega,$     |     | 4.8        |             | nS        |
| $t_r$                     |   |  |     | 12.5       |             |           |
| $t_{d(off)}$              | Turn-Off Time <sup>E</sup>                  |  |     | 27.6       |             |           |
| $t_f$                     |   |  |     | 8.2        |             |           |

Note:

D. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$

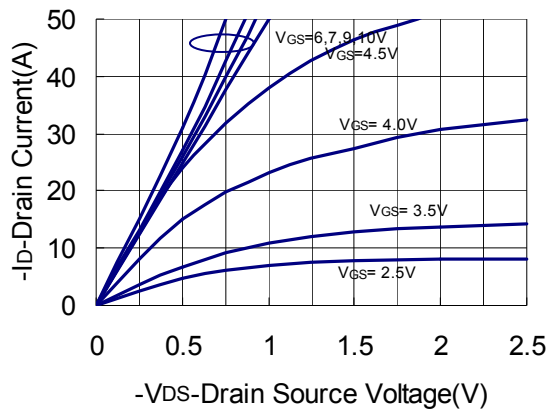
E. Pulsed width limited by maximum junction temperature.

The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date

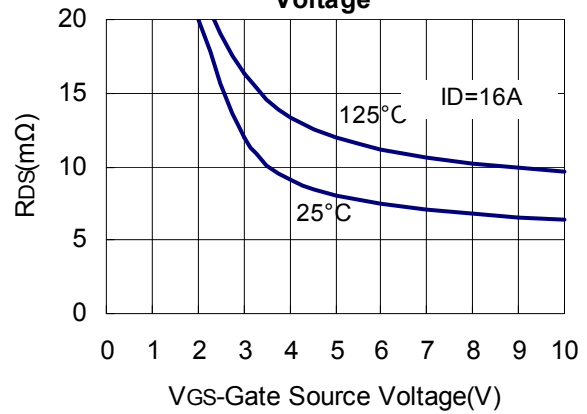
We assume no responsibility for any infringement of patents, patent rights, or other rights arising from the use of any information and circuitry in this datasheet.

## TYPICAL CHARACTERISTICS

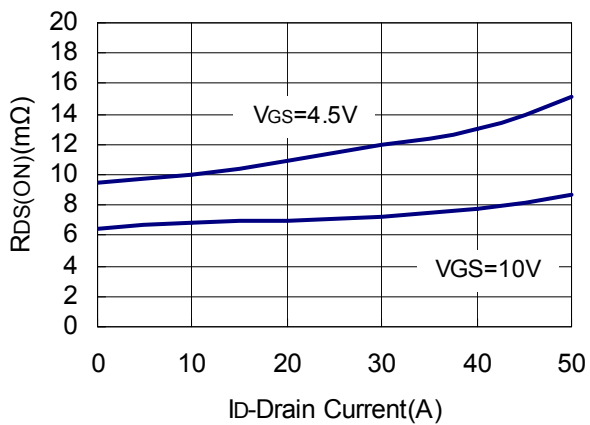
**Output Characteristics**



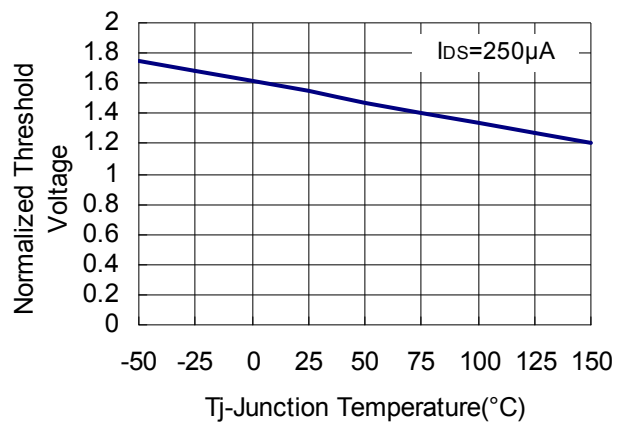
**On Resistance VS Gate Source Voltage**



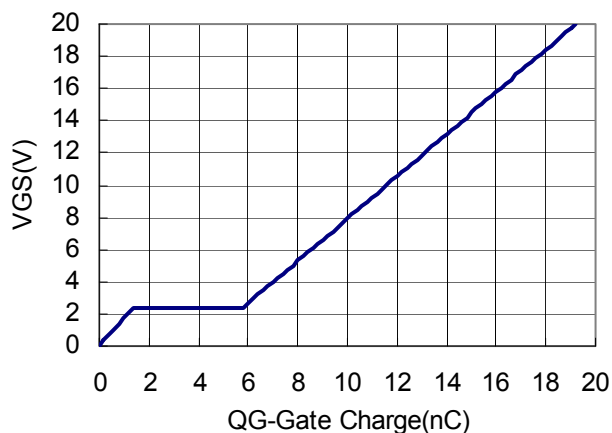
**Drain Source On Resistance**



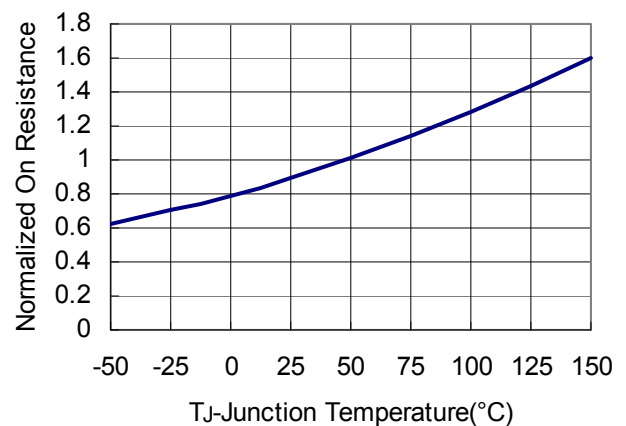
**Gate Threshold Voltage**



**Gate Charge**

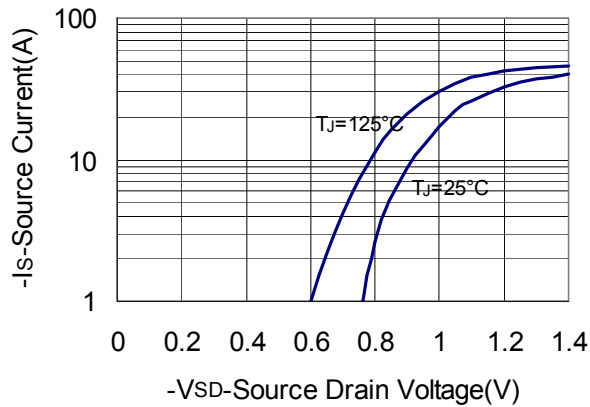


**Normalized RDS(On) V.S. TJ**

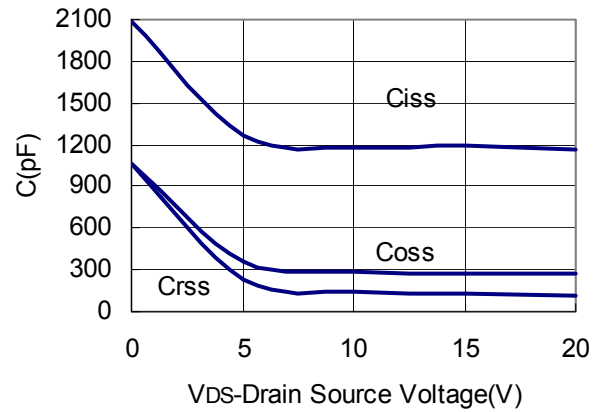


## TYPICAL CHARACTERISTICS

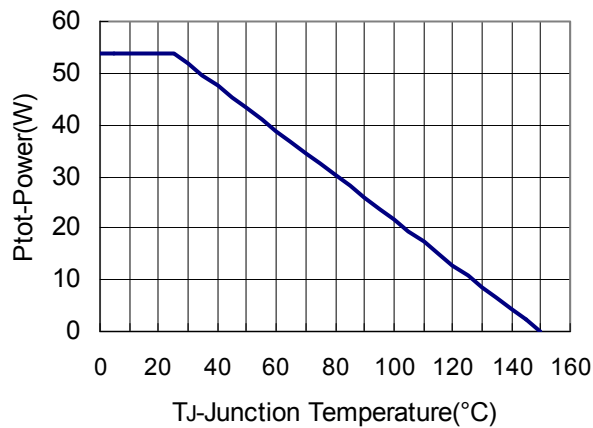
### Source Drain Diode Forward



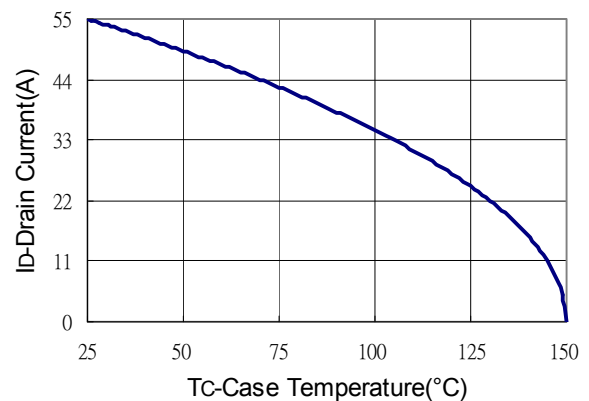
### Capacitance



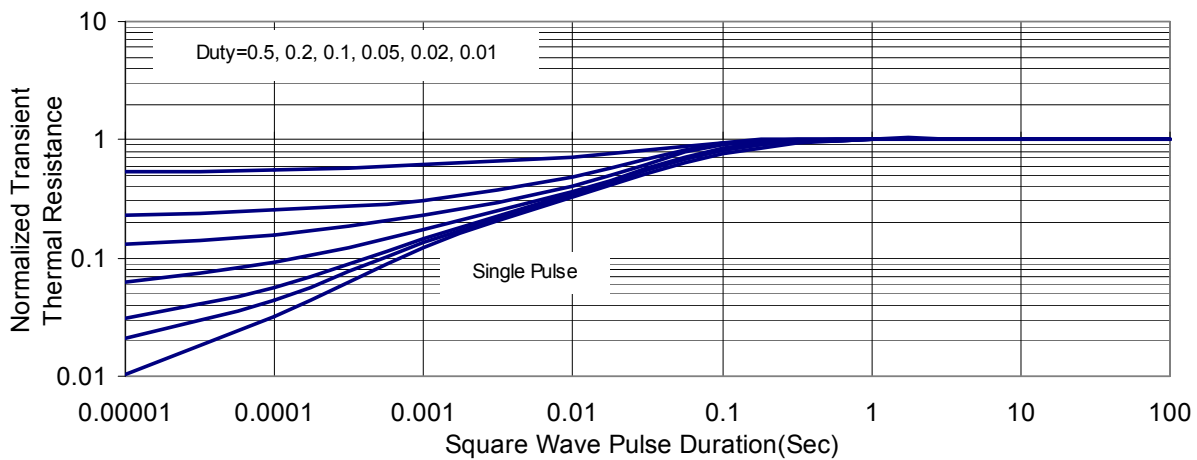
### Power Dissipation



### Drain Current



### Thermal Transient Impedance



## PDFN5X6-8 PACKAGE DIMENSIONS

| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min.                      | Max.  | Min.                 | Max.  |
| A        | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3       | 0.254REF.                 |       | 0.010REF.            |       |
| D        | 4.944                     | 5.096 | 0.195                | 0.201 |
| E        | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1       | 3.910                     | 4.110 | 0.154                | 0.162 |
| D2       | 4.824                     | 4.976 | 0.190                | 0.196 |
| E1       | 3.375                     | 3.575 | 0.133                | 0.141 |
| E2       | 5.674                     | 5.826 | 0.223                | 0.229 |
| b        | 0.350                     | 0.450 | 0.014                | 0.018 |
| e        | 1.270TYP.                 |       | 0.050TYP.            |       |
| k        | 1.190                     | 1.390 | 0.047                | 0.055 |
| L        | 0.559                     | 0.325 | 0.011                | 0.013 |
| L1       | 0.424                     | 0.725 | 0.027                | 0.029 |
| H        | 0.574                     | 0.325 | 0.011                | 0.013 |
| $\theta$ | 10°                       | 12°   | 10°                  | 12°   |

